

RD74LVC138B

3-to-8-line Decoder / Demultiplexer

REJ03D0502-0200 Rev.2.00 Jan. 14, 2005

Description

The RD74LVC138B has three binary select inputs in a 16 pin package. If the device is enabled these inputs determine which one of the eight normally high outputs will go low. Two active low and one active high enables are provided to ease the cascading of decoders. Low voltage and high-speed operation is suitable at the battery drive product (note type personal computer) and low power consumption extends the life of a battery for long time operation.

Features

- $V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}$
- All inputs V_{IH} (Max.) = 5.5 V (@ V_{CC} = 0 V to 5.5 V)
- Typical V_{OL} ground bounce < 0.8 V (@ V_{CC} = 3.3 V, Ta = 25°C)
- Typical V_{OH} undershoot > 2.0 V (@ V_{CC} = 3.3 V, Ta = 25°C)
- High output current $\pm 4 \text{ mA} (@V_{CC} = 1.65 \text{ V})$
 - $\pm 8 \text{ mA} (@V_{CC} = 2.3 \text{ V})$
 - $\pm 12 \text{ mA } (@V_{CC} = 2.7 \text{ V})$
 - ± 24 mA (@V_{CC} = 3.0 V to 5.5 V)
- Ordering Information

Part Name	Package Type	Package Code	Package Abbreviation	Taping Abbreviation (Quantity)
RD74LVC138BFPEL	SOP-16 pin (JEITA)	FP-16DAV	FP	EL (2,000 pcs/reel)
RD74LVC138BTELL	TSSOP-16 pin	TTP-16DAV	Т	ELL (2,000 pcs/reel)

Function Table

Inputs													
	Enable			Select		Outputs							
G1	G2A	G2B	С	В	Α	Y0	Y1	Y2	Y3	Y4	Y5	Y6	Y7
X	Х	Н	Х	Х	Х	Н	Н	Н	Н	Н	Н	Н	Н
Χ	Н	Х	X	X	X	Н	Н	Н	Н	Н	Н	Н	Н
L	Х	X	X	X	X	Н	Н	Н	Н	Н	Н	Н	Н
Н	L	L	L	L	L	L	Н	Н	Н	Н	Н	Н	Н
Н	L	L	L	L	Н	Н	L	Н	Н	Н	Н	Н	Н
Н	L	L	L	Н	L	Н	Н	L	Н	Н	Н	Н	Н
Н	L	L	L	Н	Н	Н	Н	Н	L	Н	Н	Н	Н
Н	L	L	Н	L	L	Н	Н	Н	Н	L	Н	Н	Н
Н	L	L	Н	L	Н	Н	Н	Н	Н	Н	L	Н	Н
Н	L	L	Н	Н	L	Н	Н	Н	Н	Н	Н	L	Н
Н	L	L	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	L

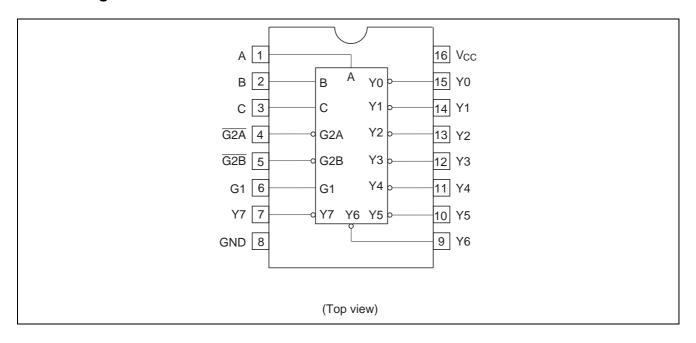
H: High level

L: Low level

X: Immaterial

Pin Arrangement

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Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V _{CC}	-0.5 to 7.0	V	
Input diode current	I _{IK}	-50	mA	$V_1 = -0.5 \text{ V}$
Input voltage	Vı	-0.5 to 7.0	V	
Output diode current	I _{OK}	-50	mA	V _O = -0.5 V
		50		V _O = V _{CC} +0.5 V
Output voltage	Vo	-0.5 to V _{CC} +0.5	V	
Output current	Io	±50	mA	
V _{CC} , GND current / pin	I _{CC} or I _{GND}	100	mA	
Storage temperature	Tstg	-65 to +150	°C	

Note: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.



Recommended Operating Conditions

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Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V _{CC}	1.5 to 5.5	V	Data retention
		1.65 to 5.5		At operation
Input / output voltage	Vı	0 to 5.5	V	A, B, C, G1, <u>G2A</u> , <u>G2B</u>
	Vo	0 to V _{CC}	V	Y0 to Y7
Operating temperature	Та	-40 to 85	°C	
Output current	Іон	-4	mA	V _{CC} = 1.65 V
		-8		V _{CC} = 2.3 V
		-12		V _{CC} = 2.7 V
		-24		V _{CC} = 3.0 V to 5.5 V
	I _{OL}	4	mA	V _{CC} = 1.65 V
		8		V _{CC} = 2.3 V
		12		V _{CC} = 2.7 V
		24		V _{CC} = 3.0 V to 5.5 V
Input rise / fall time *1	t _r , t _f	20	ns/V	V _{CC} = 1.65 V to 2.7 V
		10		V _{CC} = 3.0 V to 5.5 V

Notes: 1. This item guarantees maximum limit when one input switches. Waveform: Refer to test circuit of switching characteristics.

Electrical Characteristics

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			Ta = -40 to 85°C			
Item	Symbol	V _{cc} (V)	Min	Max	Unit	Test Conditions
Input voltage	V _{IH}	1.65 to 1.95	V _{CC} ×0.65	_	V	
		2.3 to 2.7	1.7	_		
		2.7 to 3.6	2.0	_		
		4.5 to 5.5	V _{CC} ×0.7	_		
	V_{IL}	1.65 to 1.95	_	V _{CC} ×0.35	V	
		2.3 to 2.7	_	0.7		
		2.7 to 3.6	_	0.8		
		4.5 to 5.5	_	V _{CC} ×0.3		
Output voltage	V _{OH}	1.65 to 5.5	V _{CC} -0.2	_	V	$I_{OH} = -100 \mu A$
		1.65	1.2	_		$I_{OH} = -4 \text{ mA}$
		2.3	1.7	_		$I_{OH} = -8 \text{ mA}$
		2.7	2.2		_	$I_{OH} = -12 \text{ mA}$
		3.0	2.4	_		
		3.0	2.2	_		$I_{OH} = -24 \text{ mA}$
		4.5	3.8	_		
	V_{OL}	1.65 to 5.5	_	0.2	V	I _{OL} = 100 μA
		1.65	_	0.45		I _{OL} = 4 mA
		2.3		0.7		$I_{OL} = 8 \text{ mA}$
		2.7		0.4		I _{OL} = 12 mA
		3.0	_	0.55		I _{OL} = 24 mA
		4.5	_	0.55		
Input current	I _{IN}	0 to 5.5	_	±5.0	μΑ	V _{IN} = 5.5 V or GND
Quiescent supply	Icc	2.7 to 3.6		±5.0	μΑ	V _{IN} = 3.6 V to 5.5 V
current		2.7 to 5.5		5.0		$V_{IN} = V_{CC}$ or GND
	ΔI_{CC}	2.7 to 3.6		500	μΑ	V_{IN} = one input at(V_{CC} -0.6)V, other inputs at V_{CC} or GND

Switching Characteristics

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			Ta = −40 to 85°C				From	То
Item	Symbol	V _{cc} (V)	Min	Тур	Max	Unit	(Input)	(Output)
Propagation delay time	t _{PLH}	1.8±0.15	1.0	_	22.0	ns	A, B, C	Y0 to Y7
	t _{PHL}	2.5±0.2	1.0	_	9.9			
		2.7	1.0	_	7.9			
		3.3±0.3	1.0	_	6.7			
		5.0±0.5	1.0	_	6.0			
	t _{PLH}	1.8±0.15	1.0	_	21.0	ns	G2A, G2B	Y0 to Y7
	t _{PHL}	2.5±0.2	1.0	_	9.4	7		
		2.7	1.0	_	7.4			
		3.3±0.3	1.0	_	6.5			
		5.0±0.5	1.0	_	6.0			
	t _{PLH}	1.8±0.15	1.0	_	20.3	ns	G1	Y0 to Y7
	t _{PHL}	2.5±0.2	1.0	_	8.4			
		2.7	1.0	_	6.4			
		3.3±0.3	1.0	_	5.8			
		5.0±0.5	1.0	_	5.0			
Output skew between	t _{OSLH}	1.8±0.15	_	_	_	ns		
pins*1	toshl	2.5±0.2	_	_	_			
		2.7	_	_	_			
		3.3±0.3	_	_	1.0			
		5.0±0.5	_	_	1.0			
Input capacitance	C _{IN}	3.3		5.0	_	pF		

Note: 1. This parameter is characterized but not tested.

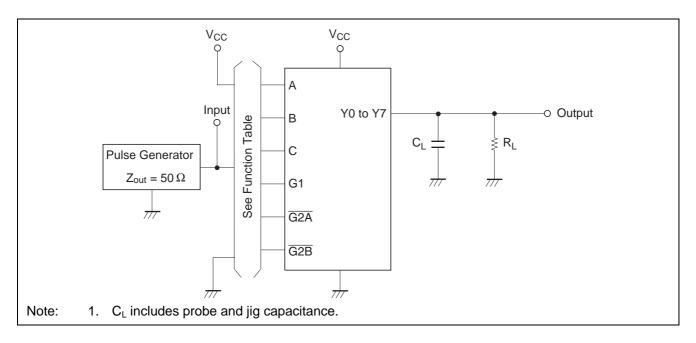
 $t_{\text{OSLH}} = |t_{\text{PLHm}} - t_{\text{PLHn}}|, \ t_{\text{OSHL}} = |t_{\text{PHLm}} - t_{\text{PHLn}}|$

Operating Characteristics

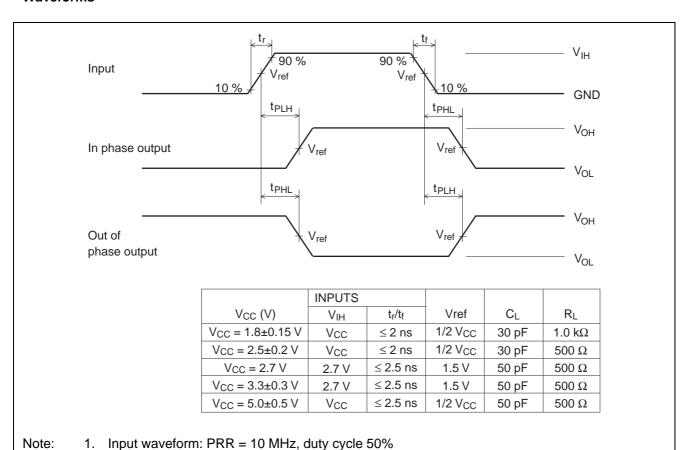
			Ta = 25°C				
Item	Symbol	VCC = (V)	Min	Тур	Max	Unit	Test Conditions
Power dissipation capacitance	C _{PD}	1.8	_	25	_	pF	f = 10 MHz
		2.5	_	26	_		
		3.3	_	27	_		
		5.0	_	30	_		



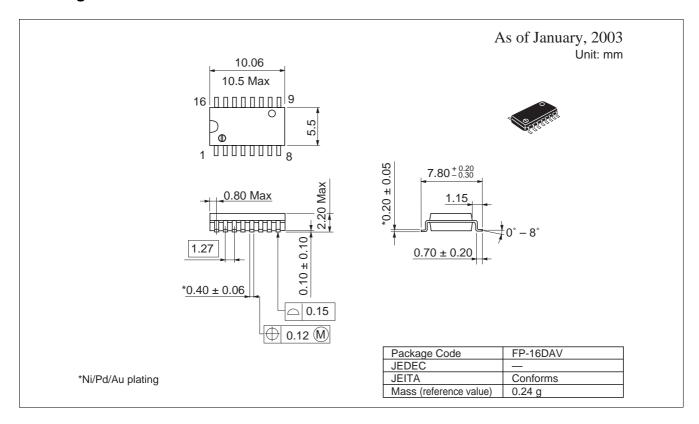
Test Circuit www.DataSheet4U.com

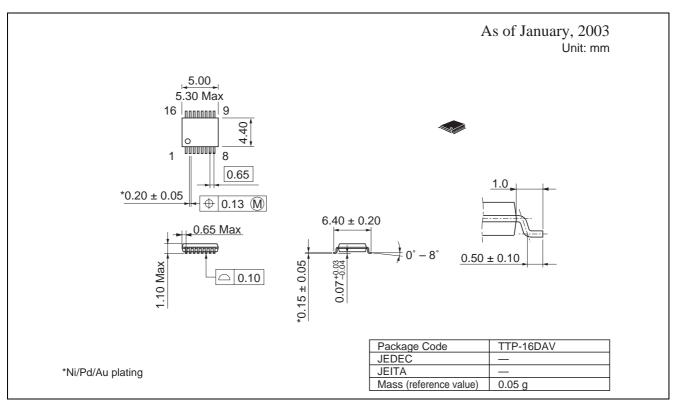


Waveforms



Package Dimensions





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